

**NPN SILICON TRIPLE DIFFUSED TRANSISTOR
FOR HIGH-SPEED HIGH-VOLTAGE SWITCHING**

The 2SC4942 is a transistor developed for high-speed high-voltage switching. This transistor is ideal for use in switching devices such as switching regulators and DC/DC converters.

FEATURES

- New package with dimensions in between those of small signal and power signal package
- High voltage
- Fast switching speed
- Complementary transistor with the 2SA1871

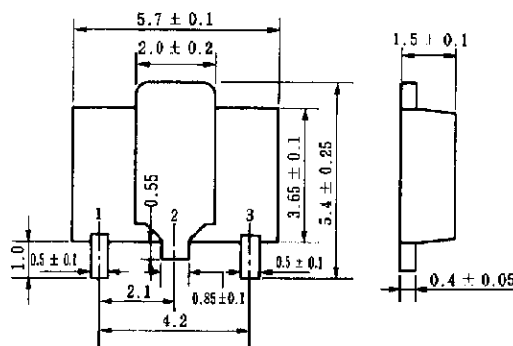
QUALITY GRADES

- Standard

Please refer to "Quality Grades on NEC Semiconductor Devices" (Document No. C11531E) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Conditions	Ratings	Unit
Collector to base voltage	V_{CBO}		600	V
Collector to emitter voltage	V_{CEO}		600	V
Emitter to base voltage	V_{EBO}		7.0	V
Collector current (DC)	$I_{D(DC)}$		1.0	A
Collector current (pulse)	$I_{D(pulse)}$	PW ≤ 10 ms, duty cycle ≤ 50 %	2.0	A
Total power dissipation	P_T	7.5 cm ² × 0.7 mm ceramic board mounted	2.0	W
Junction temperature	T_j		150	°C
Storage temperature	T_{stg}		-55 to +150	°C

PACKAGE DRAWING (UNIT: mm)

Electrode connection

1. Emitter
2. Collector
3. Base

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

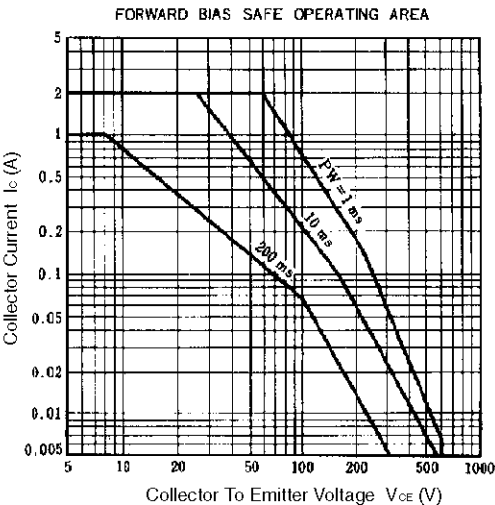
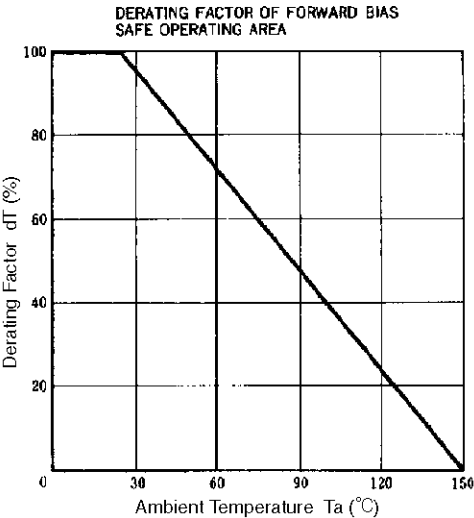
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

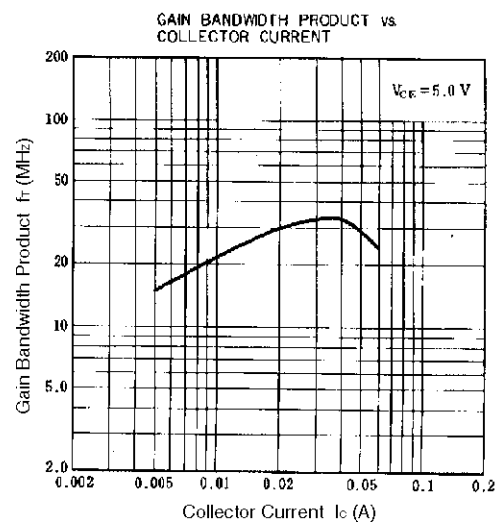
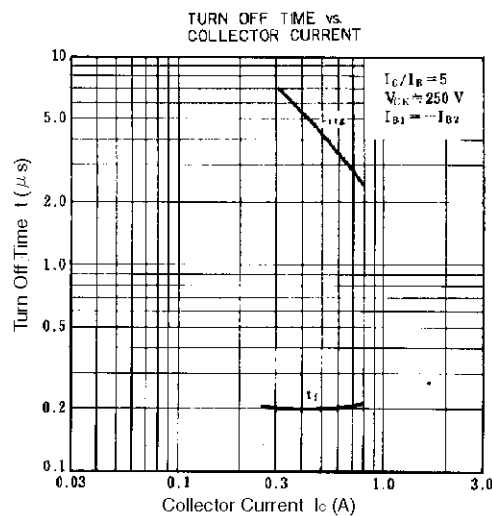
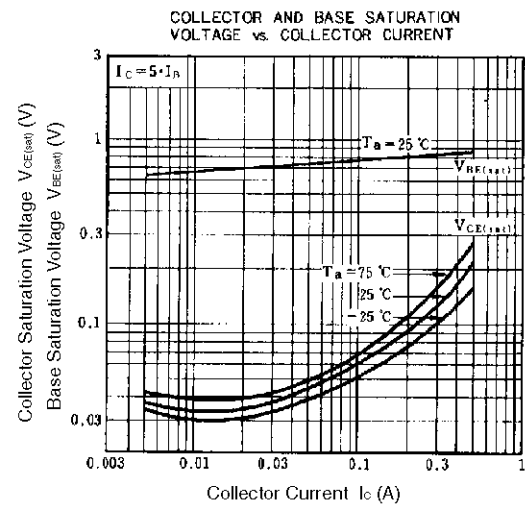
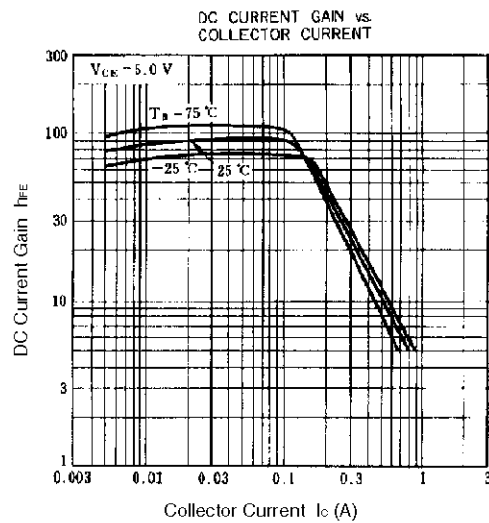
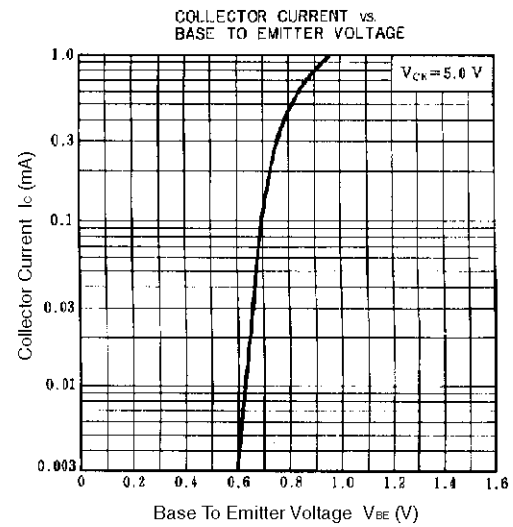
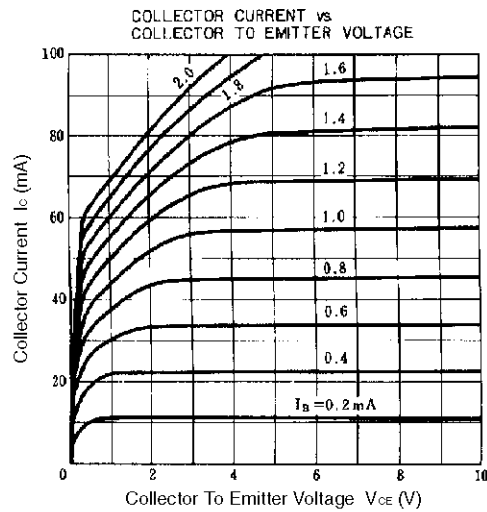
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	ICBO	V _{CB} = 600 V, I _E = 0			10	μA
Emitter cutoff current	IEBO	V _{EB} = 7.0 V, I _C = 0			10	μA
DC current gain	h _{FE1}	V _{CE} = 5.0 V, I _C = 0.1 A	30	55	120	—
DC current gain	h _{FE2}	V _{CE} = 5.0 V, I _C = 0.5 A	5	10		—
Collector saturation voltage	V _{CE(sat)}	I _C = 400 mV, I _B = 80 mA		0.35	1.0	V
Base saturation voltage	V _{BE(sat)}	I _C = 400 mV, I _B = 80 mA		0.9	1.2	V
Gain bandwidth product	f _T	V _{CE} = 5.0 V, I _E = -50 mA		30		MHz
Output capacitance	C _{ob}	V _{CB} = 10 V, I _E = 0, f = 1.0 MHz		15		pF
Turn-on time	t _{ON}	I _C = 0.5 A, V _{CC} = 250 V I _{B1} = -I _{B2} = 0.1 A R _L = 500 Ω		0.1	0.5	μs
Storage time	t _{stg}			4.0	5.0	μs
Fall time	t _f			0.2	0.5	μs

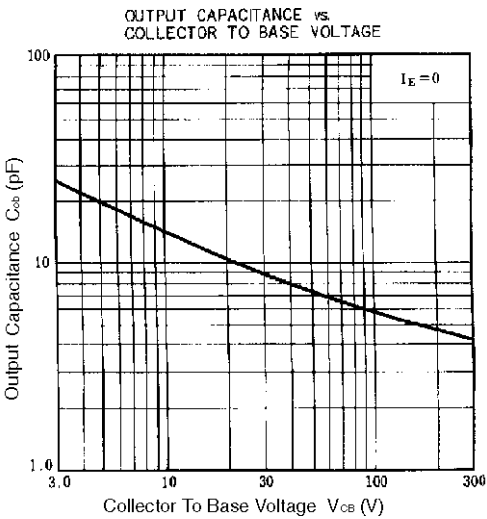
h_{FE} CLASSIFICATION

Marking	AA1	AA2	AA3
h _{FE1}	30 to 60	40 to 80	60 to 120

TYPICAL CHARACTERISTICS (Ta = 25°C)







[MEMO]

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